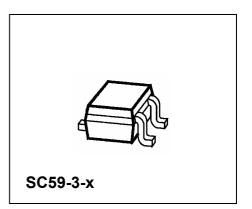


Low Power Hall Switch

TLE 4913

Features

- Micro power design
- 2.4 V to 5.5 V battery operation
- High sensitivity and high stability of the magnetic switching points
- High resistance to mechanical stress
- Digital output signal
- Switching for both poles of a magnet (omnipolar)



Functional Description

The TLE4913 is an Integrated Hall-Effect Sensor designed specifically to meet the requirements of low-power devices. e.g. as an On/Off switch in Cellular Flip-Phones, with battery operating voltages of 2.4V - 5.5V.

Precise magnetic switching points and high temperature stability are achieved through the unique design of the internal circuit.

An onboard clock scheme is used to reduce the average operating current of the IC.

During the operate phase the IC compares the actual magnetic field detected with the internally compensated switching points. The output Q is switched at the end of each operating phase.

During the Stand-by phase the output stage is latched and the current consumption of the device reduced to some µA.

The IC switching behaviour is Omnipolar, i.e. it can be switched on with either the North or South pole of a magnet.

Туре	Marking	Ordering Code	Package
TLE 4913	13s 013	Q62705K 619	SC 59-3-x

Data Sheet 1 V 2.2, 2004-03-09



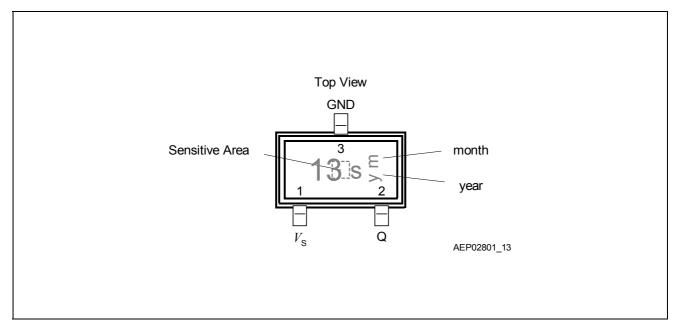


Figure 1 Pin Configuration (top view)

Pin Definitions and Functions

Pin	Symbol	Function
1	V_{S}	Supply Voltage
2	Q	Open Drain Input
3	Gnd	Ground

Data Sheet 2 V 2.2, 2004-03-09



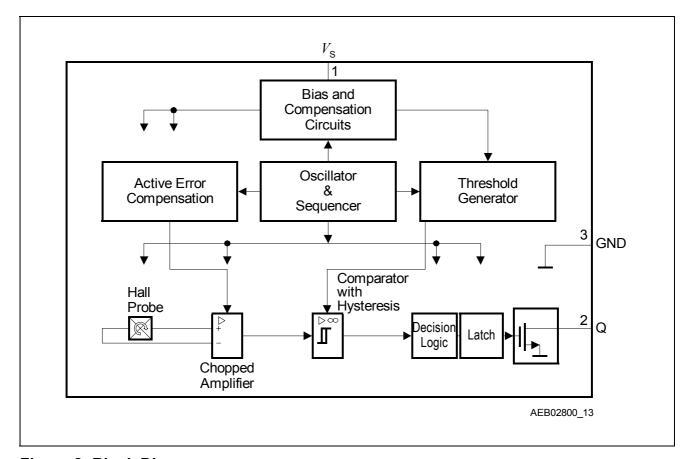


Figure 2 Block Diagram

Circuit Description

The Low Power Hall IC Switch comprises a Hall probe, bias generator, compensation circuits, oscillator, output latch and an n-channel open drain output transistor.

The bias generator provides currents for the Hall probe and the active circuits. Compensation circuits stabilize the temperature behavior and reduce technology variations.

The Active Error Compensation rejects offsets in signal stages and the influence of mechanical stress to the Hall probe caused by molding and soldering processes and other thermal stresses in the package. This chopper technique together with the threshold generator and the comparator ensures high accurate magnetic switching points.

Very low power consumption is achieved with a timing scheme controlled by an oscillator and a sequencer. This circuitry activates the sensor for 50 μ s (typical operating time) sets the output state after sequential questioning of the switch points and latches it with the beginning of the following standby phase (max. 200 ms). In the standby phase the average current is reduced to typical 4 μ A. Because of the long standby time compared to the operating time the overall averaged current is only slightly higher than the standby current.

The output transistor can sink up to 1 mA with a maximal saturation voltage V_{QSAT} .



Absolute Maximum Ratings

Parameter	Symbol	Limit	t Values	Unit	Notes
		min.	max.		
Supply Voltage	V_{S}	- 0.3	5.5	V	
Supply Current	$I_{\mathbb{S}}$	– 1	2.5	mA	
Output Voltage	V_{Q}	- 0.3	5.5	V	
Output Current	I_{Q}	– 1	2	mA	
Junction temperature	T_{i}	- 40	150	°C	
Storage temperature	$T_{\mathbb{S}}$	- 40	150	°C	
Magnetic Flux Density	В	_	unlimited	mT	
Thermal Resistance P-SC59-3-x	R_{thJA}	_	35	K/W	

Note: Stresses above those listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD Protection

Human Body Model (HBM) tests according to: EOS/ESD Association Standard S5.1-1993 and Mil. Std. 883D method 3015.7

Parameter	Symbol	l Limit Values		Unit	Notes	
	-	Min.	Max.			
ESD Voltage	V_{ESD}		± 4	kV	$R = 1.5 \text{ k}\Omega,$	
					C = 100 pF;	
					T = 25 °C	

Data Sheet 4 V 2.2, 2004-03-09



Operating Range

Parameter	Symbol	Limit Values			Unit	Notes
		Min.	typ.	max.		
Supply voltage	V_{S}	2.4	2.7	5.5	V	1)
Output voltage	V_{Q}	- 0.3	2.7	5.5	V	
Ambient Temperature	T_{A}	- 40	25	85	°C	

 $^{^{\}rm 1)}$ A Ceramic Bypass Capacitor of 100 nF at $V_{\rm S}$ to GND is highly recommended.

AC/DC Characteristics

Parameter	Symbol	L	imit Valu	es	Unit	Notes
		Min.	typ.	Max.		
Averaged Supply Current	I_{SAVG}	1	4	20	μA	
Averaged Supply Current during Operating Time	I_{SOPAVG}	0.5	1.1	2.5	mA	
Transient Peak Supply Current during Operating Time	I_{SOPT}	_	_	2.5	mA	<i>t</i> < 100 ns
Supply Current during Standby Time	I_{SSTB}	1	3.5	20	μΑ	
Output Saturation Voltage	V_{QSAT}	_	0.13	0.4	V	$I_{\rm Q}$ = 1 mA
Output Leakage Current	I_{QLEAK}	_	0.01	1	μA	
Output Rise Time	t _r	_	0.5	1	μs	R_{L} = 2.7 k Ω ; C_{L} = 10 pF
Output Fall Time	t_{f}	_	0.1	1	μs	R_{L} = 2.7 k Ω ; C_{L} = 10 pF
Operating Time	$t_{\sf op}$	15	50	93 1) 2)	μs	
Standby Time	t_{Stb}	_	130	240 ³⁾	ms	
Duty Cycle	t_{op} / t_{stb}	_	0.039	_	%	
Start-up Time of IC	$t_{\sf stu}$	_	6	12	μs	4)

 $^{^{1)}}$ for V_S=3.5V the max. Operating Time $t_{\rm op\ max}$ = 85 μ s

Data Sheet 5 V 2.2, 2004-03-09

 $^{^{2)}}$ includes the Start-up Time $t_{\rm stu}$

³⁾ for V_S =3.5V the max. Standby Time $t_{stb\ max}$ = 220ms ⁴⁾ initial power on time. V_S must be applied in this time (typ. 6µs to max. 12µs) to get already a valid output state after the first operating phase (typ. 56µs). For rise times of V_S > 12µs, the output state is valid after the second operating phase (includes one standby phase), e.g. happens only when the battery in flip phones is changed.



Magnetic Characteristics

Parameter	Symbol	Symbol Limit Values			Unit	Notes
		min.	typ.	max.		
Operate Points	B _{OPS}	2	3.5	5	mT	1)
(Output on)	B _{OPN}	– 5	-3.5	- 2	mT	
Release Points	B _{RPS}	1,2	2.7	4.2	mT	1)
(Output off)	B_RPN	- 4.2	-2.6	- 1,2	mT	
Hysteresis	B _{HYS}	0.2	0.8	1,6	mT	

¹⁾ Positive magnetic fields are related to the approach of a magnetic south pole to the branded side of package

Note: The listed AC/DC and magnetic characteristics are ensured over the operating range of the integrated circuit. Typical characteristics specify mean values expected over the production spread. If not other specified, typical characteristics apply at T_j = 25 °C and V_S = 2.7 V

Data Sheet 6 V 2.2, 2004-03-09



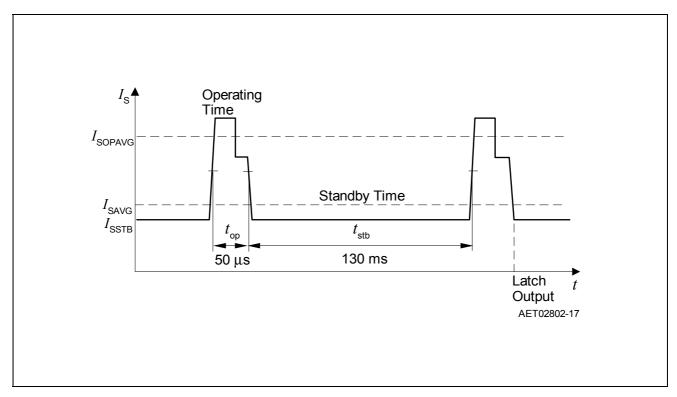


Figure 3 Timing Diagram

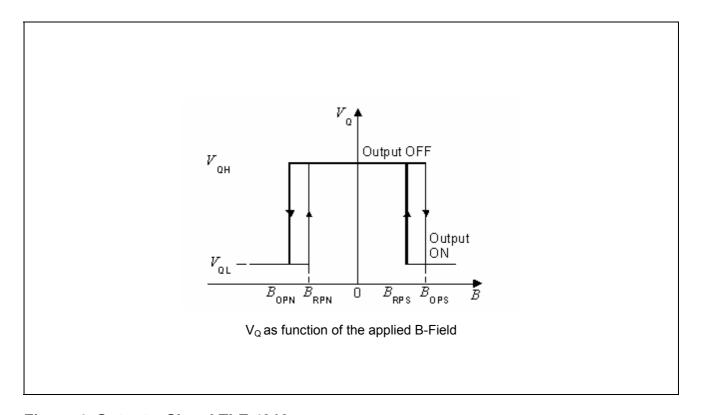
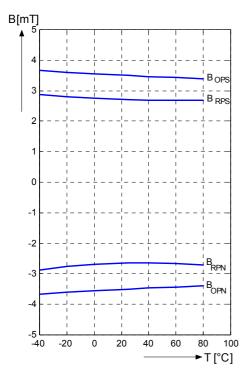


Figure 4 Output - Signal TLE 4913

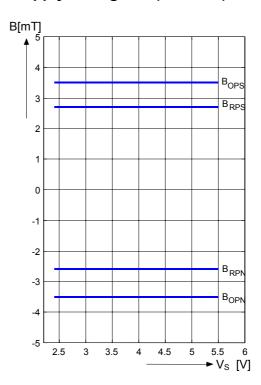


All curves reflect typical values at the given parameters for T_A in °C and V_S in V.

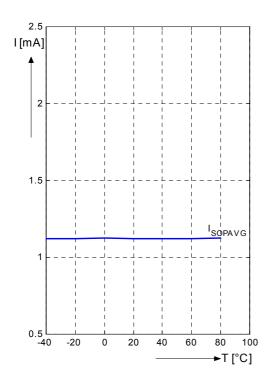
Magnetic Switching Points versus Temperature ($V_S=2.7V$)



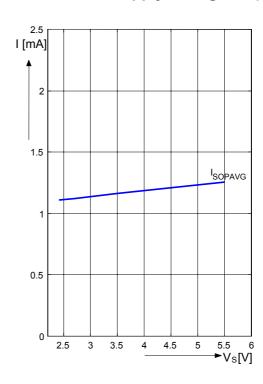
Magnetic Switching Points versus Supply Voltage V_S (T_A=20°C)



Supply current I_{SOPAVG} during Operating Time versus Temperature ($V_S=2.7V$)



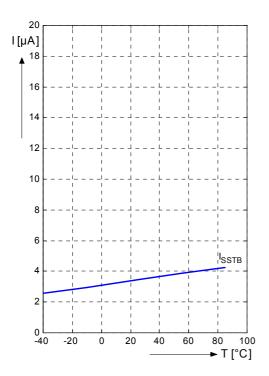
Supply current I_{SOPAVG} during Operating Time versus Supply Voltage V_S ($T_A=20^{\circ}C$)



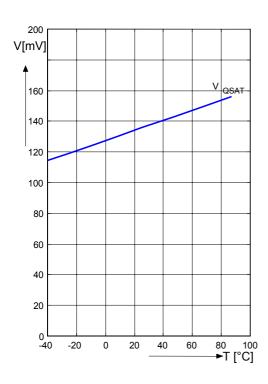
Data Sheet 8 V 2.2, 2004-03-09



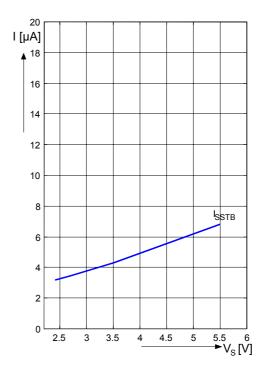
Supply current I_{SSTB} during Standby Time versus Temperature ($V_S=2.7V$)



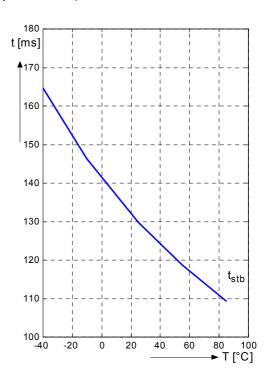
Output Saturation voltage V_{QSAT} versus Temperature ($I_Q=1mA$)



Supply current I_{SSTB} during Standby Time versus Supply Voltage V_S (T_A =20°C)



Standby Time t_{stb} versus Temperature $(V_S = 2.7V)$



Data Sheet 9 V 2.2, 2004-03-09



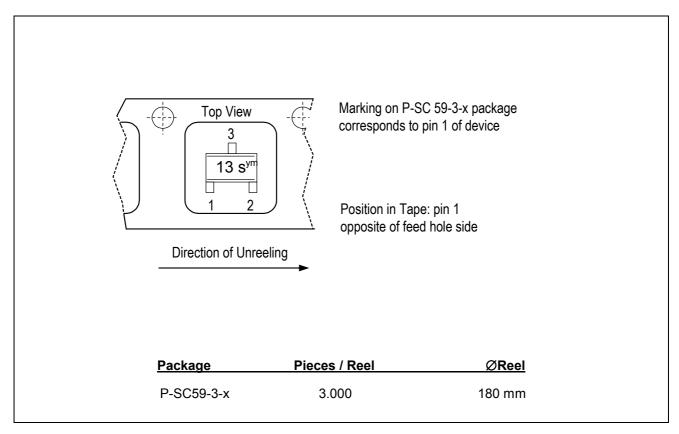


Figure 5 Marking and Tape Loading Orientation

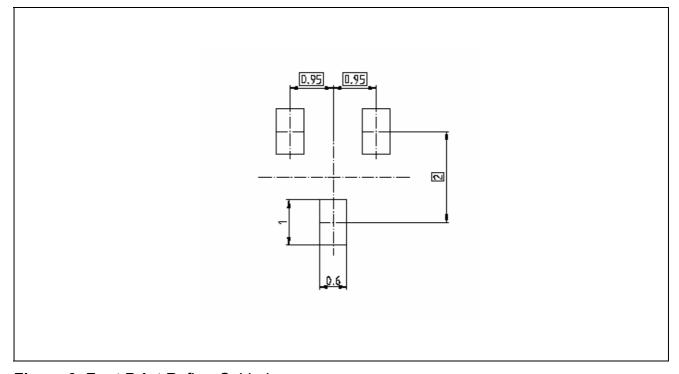
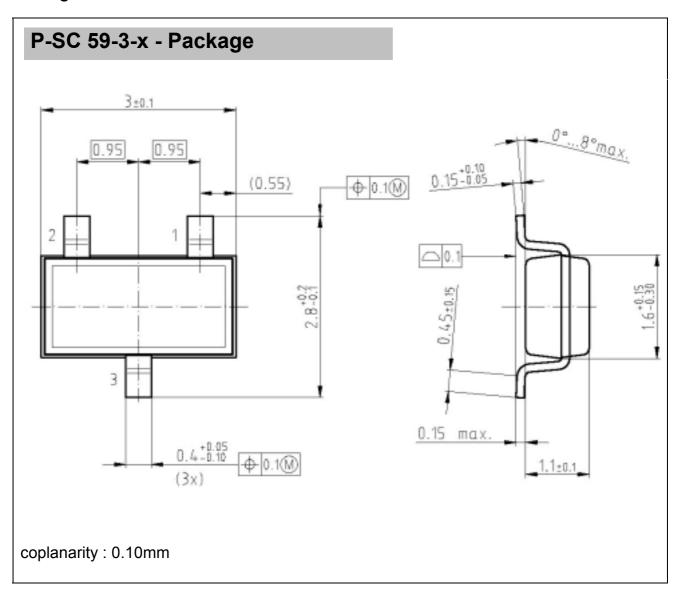


Figure 6 Foot Print Reflow Soldering



Package Dimensions



Sorts of Packing

Package outlines for tubes, trays etc. are contained in our Data Book "Package Information".

SMD = Surface Mounted Device



TLE4913 Revision His	story: 2004-03-09	V 2.2
Previous Vers	sion: 2003-07-16	
Page	Subjects (major changes since last revision)	
4	ESD Level adapted to ±4 kV	

For questions on technology, delivery and prices please contact the Infineon Technologies Offices in Germany or the Infineon Technologies Companies and Representatives worldwide: see our webpage at http://www.infineon.com

We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all? Your feedback will help us to continuously improve the quality of this document.

Please send your proposal (including a reference to this document) to:

feedback.sensors@infineon.com

Edition 2002-08-22 Published by Infineon Technologies AG St.-Martin-Strasse 53 D-81541 München © Infineon Technologies AG 2000 All Rights Reserved.

Attention please!

The information herein is given to describe certain components and shall not be considered as warranted characteristics.

Terms of delivery and rights to technical change reserved.

We hereby disclaim any and all warranties, including but not limited to warranties of non-infringement, regarding circuits, descriptions and charts stated herein.

Infineon Technologiesis an approved CECC manufacturer.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office in Germany or our Infineon Technologies Representatives worldwide (see address list).

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Data Sheet 12 V 2.2. 2004-03-09

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Board Mount Hall Effect/Magnetic Sensors category:

Click to view products by Infineon manufacturer:

Other Similar products are found below:

HGPRDT005A AH1808-P-A AH277AZ4-AG1 AV-10379 AV-10448 SS41C AH1894-Z-7 ATS601LSGTN-HT-WU4-T ATS601LSGTN-LT-WU4-T TLE4917 50017859-003 TY-13101 SS85CA AH277AZ4-BG1 TLE49614MXTSA1 AH3382-P-B AH3377-P-B AH9250-W-7 AH211Z4-AG1 AH3360-FT4-7 SS460S-100SAMPLE 50065820-03 TLE4941PLUSCB AH374-P-A AH1806-P-A AH374-W-7 SS460P-T2 AH1912-FA-7 SS413F TLE5046ICAKLRHALA1 TLE49421CHAMA2 TLE4941PLUSCXAMA1 AH1912-W-EVM AH1903-FA-EVM AH3774-W-EVM AH49FNTR-EVM MMC5633NJL AH3360-FA-EVM AH8502-FDC-EVM AH3366Q-SA-EVM AH3774-P-EVM KTH1601SU-ST3 MG910 MG910M MG911 MG610 MW921 MW922 TLE4998S3XALA1 TLE5011FUMA1